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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/643,526	08/22/2000	Tongbi Jiang	303.705US1	9708	
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Schwegman, Lundberg, Woessner & Kluth, P.A.			EXAMINER		
Attn: Danny J. P.O. Box 2938			BUI, HUNG S		
Minneapolis, MN 55402			ART UNIT	PAPER NUMBER	
			2841		
			DATE MAILED: 06/30/2003	DATE MAILED: 06/30/2003	

Please find below and/or attached an Office communication concerning this application or proceeding.

		nn				
	Application No.	Applicant(s)				
	09/643,526	JIANG ET AL.				
Office Action Summary	Examiner	Art Unit				
	Hung S Bui	2841				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the	correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply sepecified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be ti or within the statutory minimum of thirty (30) da will apply and will expire SIX (6) MONTHS fror cause the application to become ABANDON.	imely filed ys will be considered timely. In the mailing date of this communication. ED (35 U.S.C. § 133).				
Status 1) Responsive to communication(s) filed on						
/ <u>-</u>	— · is action is non-final.					
, <u> </u>		prosecution as to the merits is				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims						
4) Claim(s) 1-25 is/are pending in the application	l .					
4a) Of the above claim(s) is/are withdrawn from consideration.						
5)⊠ Claim(s) <u>20-25</u> is/are allowed.						
6)⊠ Claim(s) <u>1-19</u> is/are rejected.	6)⊠ Claim(s) <u>1-19</u> is/are rejected.					
7) Claim(s) is/are objected to.	Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/o	r election requirement.					
Application Papers						
9) The specification is objected to by the Examiner.						
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). 11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:	, promise and a control of the control	-, (-, (-,-				
1. Certified copies of the priority document	s have been received.					
2. Certified copies of the priority document		tion No.				
Copies of the certified copies of the prior application from the International Bu See the attached detailed Office action for a list	rity documents have been receiv reau (PCT Rule 17.2(a)).	ved in this National Stage				
14) Acknowledgment is made of a claim for domesti	c priority under 35 U.S.C. § 119	(e) (to a provisional application).				
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Information	ry (PTO-413) Paper No(s) Patent Application (PTO-152)				

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DETAILED ACTION

1. The indicated allowability of claims 7-15 is withdrawn in view of a different interpretation of the prior art. Rejections based on the new interpretation of the prior art follow.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-12 are rejected under 35 U.S.C. 103(a) as being unpatentable over the prior art shown in figure of Juneja et al. [US 6,127,728] (Juneja et al., hereinafter) in view of Beck [US 2,695,351] and Benzinger [US 3,617,613].

Regarding claims 1-2 and 4, Juneja et al. disclose a circuit board (figure 1) comprising:

- a core layer (22); and
- a surface layer (20) having a surface layer thickness between about 10 and 30% of the circuit board thickness (figure 1, column 1, lines 8-21).

Juneja et al. disclose the instant claimed invention except for the surface layer being free of fibers and the core having at least one fiber.

Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (figure 13).

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It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of Juneja et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

Benzinger discloses a printed circuit board (1) having a core formed of processed fiber glass (column 3, lines 34-45).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use fiber glass in the resin of the core of Juneja et al. in view of Beck, as suggested by Benzinger, for the purpose of reinforcing/strengthening the printed circuit board.

Regarding claim 3, Juneja et al. in view of Beck disclose the instant claimed invention except for the surface layer being formed of a non-woven glass fiber.

Benzinger et al. disclose the use of non-woven glass fiber (column 1, lines 57-65).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use a non-woven glass fiber for the surface layer of Juneja et al. in view of Beck, for the purpose of improving board flexibility.

Regarding claim 5, Juneja et al. disclose the use of resin in the core material (column 1, line 18).

Regarding claim 6, Juneja et al. disclose the instant claimed invention except for the specific thickness of the core layer.

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It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the core thickness between 0.006 and 0.012 mm, since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Regarding claims 7-12, Juneja et al. disclose a circuit board (figure 1) comprising:

- a first layer (20) having a thickness between about 10 and 15% of the circuit board thickness;
- a second layer (24) having a thickness between about 10 and 50% of the circuit board thickness; and
- a core layer (22) located between the first and second layers.

Juneja et al. disclose the instant claimed invention except for the surface layer being free of fibers and the core having at least one fiber.

Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (figure 13).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of Juneja et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

Benzinger discloses a printed circuit board (1) having a core formed of processed fiber glass (column 3, lines 34-45).

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It would have been obvious to a person having ordinary skill in the art at the time invention was made to use fiber glass in the resin of the core of Juneja et al. in view of Beck, as suggested by Benzinger, for the purpose of reinforcing/strengthening the printed circuit board.

4. Claims 13-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over the applicant admitted prior art shown in a figure 1 (AAPA, hereinafter) in view of Juneja et al. and Benzinger et al.

Regarding claims 13 and 16, AAPA discloses a circuit board assembly (figure 1) including:

- a first circuit board (105);
- a second circuit board (103) coupled to the first circuit board; and
- a die coupled to the second circuit board.

AAPA discloses the instant claimed invention except for the specific design of the second circuit board.

Juneja et al. in view of Beck and Benzinger et al. disclose a multiple layer circuit board (2) having a fibrous core with fibers having a diameter in the arrange of 0.2 to 14 microns (abstract lines 5-6) and the surface portion (7) located at a distance between about 10 to 20 percents of the thickness away from the number of fibers.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the circuit board design of Juneja et al. in view of Benzinger

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et al. for the second circuit board of AAPA, for the purpose of facilitating mounting of the die.

Regarding claims 14-15 and 17-18, AAPA discloses the instant claimed invention except for the specific type of die mounted on the second circuit board.

Official notice is taken the effect that multiple types of dies could have been used with the circuit board assembly of Juneja et al. in view of Beck and Benzinger et al. for the purpose of using the circuit board assembly for multiple purposes. MPEP 2144.03.

5. Claim 19 is rejected under 35 U.S.C. 103(a) as being unpatentable over the applicant admitted prior art shown in a figure 1 (AAPA, hereinafter) in view of Juneja et al., Benzinger et al. and Beck.

Regarding claim 19, AAPA discloses a circuit board assembly (figure 1) including:

- a first circuit board (105);
- a second circuit board (103) coupled to the first circuit board; and
- a die coupled to the second circuit board.

AAPA discloses the instant claimed invention except for the specific design of the second circuit board.

Juneja et al. in view of Benzinger et al. disclose a multiple layer circuit board (2) having a fibrous core with fibers having a diameter in the arrange of 0.2 to 14 microns

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(abstract lines 5-6) and the surface portion (7) located at a distance between about 10 to 20 percent of the thickness away from the number of fibers.

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the circuit board design of Juneja et al. in view of Benzinger et al. for the second circuit board of AAPA, for the purpose of facilitating mounting of the die.

Beck discloses a multilayer circuit board (10) having a surface layer (11) formed of a resinous material free of fibers (figure 13).

It would have been obvious to a person having ordinary skill in the art at the time invention was made to use the non fiber material for the surface layer of AAPA in view of Juneja et al. and Benzinger et al., as suggested by Beck, for the purpose of facilitating application of circuit traces on the board.

Allowable Subject Matter

6. Claims 20-25 are allowed.

The following is an examiner's statement of reasons for allowance: The prior art of record does not teach or suggest, in the claimed combination, the second circuit board having a first surface located at a first distance of between about 10 to 15 percent of the thickness away from the number of fibers and a second surface located at a second distance of between about 10 to 15 percent of the thickness away from the number of fibers and a die being coupled to the second circuit board.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably

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accompany the issue fee. Such submissions should be clearly labeled "Comments on

Statement of Reasons for Allowance."

Response to Arguments

Applicant's arguments with respect to claims 1-6 and 16-19 have been 7.

considered but are most in view of the new ground(s) of rejection.

Conclusion

Any inquiry concerning this communication or earlier communications from the 8.

examiner should be directed to Hung S Bui whose telephone number is (703) 305-8024.

The examiner can normally be reached on Monday-Friday 8:30AM-6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, David S. Martin can be reached on (703) 308-3121. The fax phone

numbers for the organization where this application or proceeding is assigned are (703)

308-7722 for regular communications and (703) 308-7724 for After Final

communications.

Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is (703) 305-

0956.

HB 6/19/03